

INTERNATIONAL STANDARD



**Specifications for particular types of winding wires –
Part 2: Solderable polyurethane enamelled round copper wire, class 130, with a
bonding layer**



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INTERNATIONAL
ELECTROTECHNICAL
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INTERNATIONAL ELECTROTECHNICAL COMMISSION

SPECIFICATIONS FOR PARTICULAR TYPES OF WINDING WIRES –

Part 2: Solderable polyurethane enamelled round copper wire, class 130, with a bonding layer

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This consolidated version of the official IEC Standard and its amendment has been prepared for user convenience.

IEC 60317-2 edition 5.1 contains the fifth edition (2019-08) [documents 55/1785/FDIS and 55/1797/RVD] and its amendment 1 (2024-06) [documents 55/1980/CDV and 55/2016/RVC].

In this Redline version, a vertical line in the margin shows where the technical content is modified by amendment 1. Additions are in green text, deletions are in strikethrough red text. A separate Final version with all changes accepted is available in this publication.

International Standard IEC 60317-2 has been prepared by IEC technical committee 55: Winding wires.

This fifth edition cancels and replaces the fourth edition published in 2012. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) addition of heat bonding test loads for nominal conductor diameters up to and including 0,050 mm;
- b) addition of pin hole test requirements according to IEC 60317-0-1:2013.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60317 series, published under the general title *Specifications for particular types of winding wires*, can be found on the IEC website.

The numbering of clauses in this standard is not continuous from Clause 21 through 30 in order to reserve space for possible future wire requirements prior to those for wire packaging.

This International Standard is to be used in conjunction with IEC 60317-0-1:2013 and its Amendment 1:2019.

The committee has decided that the contents of this document and its amendment will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn, or
- revised.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

This part of IEC 60317 forms an element of a series of standards which deals with insulated wires used for windings in electrical equipment. It is composed of the following series:

- 1) *Winding wires – Test methods* (IEC 60851 series);
- 2) *Specifications for particular types of winding wires* (IEC 60317 series);
- 3) *Packaging of winding wires* (IEC 60264 series).

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SPECIFICATIONS FOR PARTICULAR TYPES OF WINDING WIRES –

Part 2: Solderable polyurethane enamelled round copper wire, class 130, with a bonding layer

1 Scope

This part of IEC 60317 specifies the requirements of solderable enamelled round copper winding wire of class 130 with a dual coating. The underlying coating is based on polyurethane resin, which may be modified providing it retains the chemical identity of the original resin and meets all specified wire requirements. The superimposed coating is a bonding layer based on a thermoplastic resin.

NOTE A modified resin is a resin that has undergone a chemical change, or contains one or more additives to enhance certain performance or application characteristics.

The range of nominal conductor diameters covered by this standard is:

- Grade 1B: 0,020 mm up to and including 2,000 mm;
- Grade 2B: 0,020 mm up to and including 2,000 mm.

The nominal conductor diameters are specified in Clause of IEC 60317-0-1:2013.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60317-0-1:2013, *Specifications for particular types of winding wires – Part 0-1: General requirements – Enamelled round copper wire*
IEC 60317-0-1:2013/AMD1:2019

3 Terms, definitions, general notes and appearance

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 60317-0-1 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.2 General notes

3.2.1 Methods of test

Subclause 3.2.1 of IEC 60317-0-1:2013 and IEC 60317-0-1:2013/AMD1:2019 applies.

¹ There exists a consolidated edition 4.1:2021 that includes IEC 60317-0-1:2013 and its Amendment 1:2019.